2SJ496

Silicon P-Channel MOS FET High Speed Power Switching

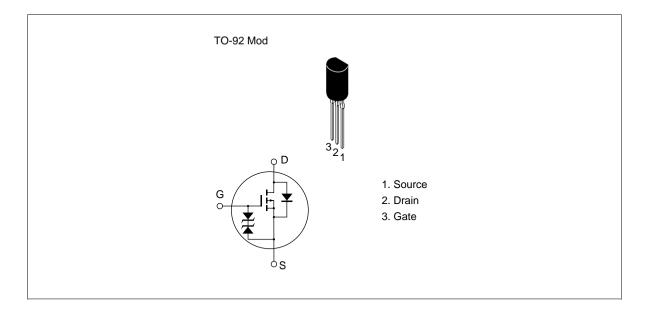
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ADE-208-482 1st. Edition

Features

- Low on-resistance $R_{DS(on)} = 0.12\Omega \ typ. \ (at \ V_{GS} = -10 \ V, \ I_D = -2.5 \ A)$
- 4V gate drive devices.
- Large current capacitance $I_D = -5 A$

Outline





2SJ496

Absolute Maximum Ratings $(Ta = 25^{\circ}C)$

Item	Symbol	Ratings	Unit
Drain to source voltage	V _{DSS}	-60	V
Gate to source voltage	V _{GSS}	±20	V
Drain current	I _D	- 5	A
Drain peak current	I _{D(pulse)} *1	-20	A
Body to drain diode reverse drain current	I _{DR}	- 5	A
Avalanche current	I _{AP} *3	- 5	A
Avalanche energy	E _{AR} *3	2.14	mJ
Channel dissipation	Pch*2	0.9	W
Channel temperature	Tch	150	°C
Storage temperature	Tstg	-55 to +150	°C

Notes: 1. PW \leq 10 μ s, duty cycle \leq 1 %

2. Value at Ta = 25°C

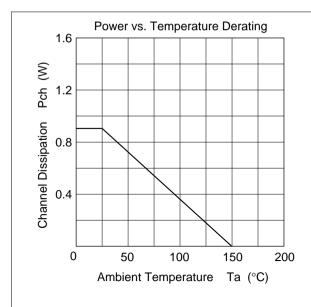
3. Value at Tch = 25°C, Rg \geq 50 Ω

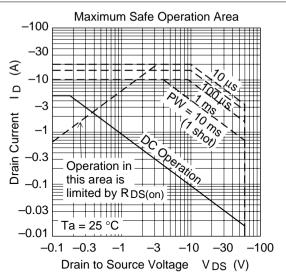
Electrical Characteristics ($Ta = 25^{\circ}C$)

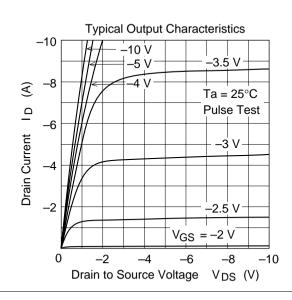
Item	Symbol	Min	Тур	Max	Unit	Test Conditions
Drain to source breakdown voltage	$V_{(BR)DSS}$	-60	_	_	V	$I_{D} = -10 \text{mA}, V_{GS} = 0$
Gate to source breakdown voltage	$V_{(BR)GSS}$	±20	_	_	V	$I_{G} = \pm 100 \mu A, V_{DS} = 0$
Zero gate voltege drain current	I _{DSS}	_	_	-10	μА	$V_{DS} = -60 \text{ V}, V_{GS} = 0$
Gate to source leak current	I _{GSS}	_	_	±10	μΑ	$V_{GS} = \pm 16V, \ V_{DS} = 0$
Gate to source cutoff voltage	$V_{GS(off)}$	-1.0	_	-2.0	V	$I_{D} = -1 \text{mA}, \ V_{DS} = -10 \text{V}$
Static drain to source on state resistance	$R_{\text{DS(on)}}$	_	0.12	0.16	Ω	$I_D = -2.5A$ $V_{GS} = -10V^{*1}$
	R _{DS(on)}	_	0.17	0.24	Ω	$I_D = -2.5A$ $V_{GS} = -4V^{*1}$
Forward transfer admittance	y _{fs}	3	5	_	S	$I_D = 2.5A, V_{DS} = 10V^{*1}$
Input capacitance	Ciss	_	600	_	pF	$V_{DS} = -10V$
Output capacitance	Coss	_	290	_	pF	$V_{GS} = 0$
Reverse transfer capacitance	Crss	_	80	_	pF	f = 1MHz
Turn-on delay time	$t_{d(on)}$	_	10	_	ns	$V_{GS} = -10V, I_{D} = -2.5A$
Rise time	t _r	_	25	_	ns	$R_L = 12\Omega$
Turn-off delay time	$t_{d(off)}$	_	95	_	ns	
Fall time	t _f	_	55	_	ns	
Body to drain diode forward voltage	V_{DF}	_	-1.0	_	V	$I_{D} = -5A, V_{GS} = 0$
Body to drain diode reverse recovery time	t _{rr}	_	65	_	ns	$I_F = -5A, V_{GS} = 0$ diF/ dt = 50A/ μ s

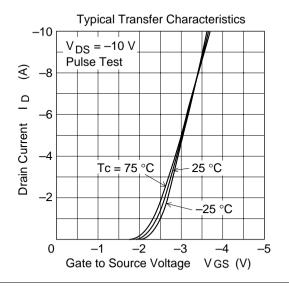
Note: 1. Pulse test

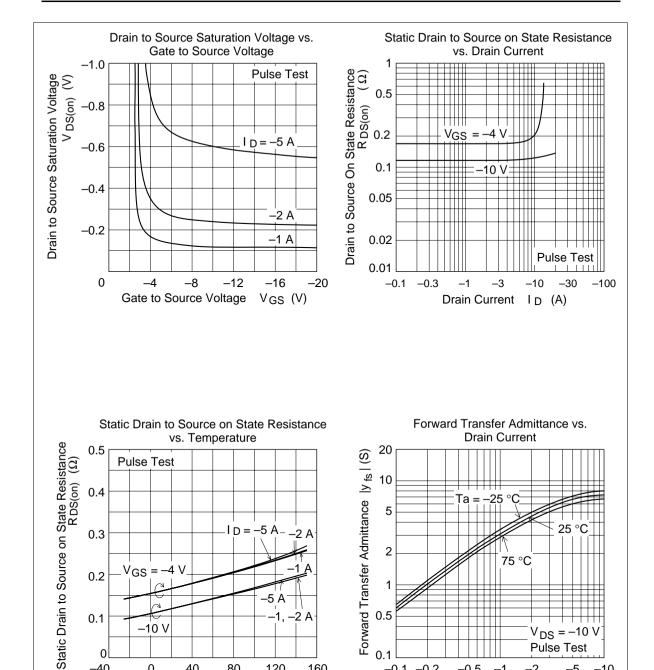
Main Characteristics











0.5

0.1

-0.1 -0.2

-0.5 -1

Drain Current ID (A)

-5 A

120

Tc (°C)

1, –2 A

160

0.2

0.1

0

-40

-10 V

0

40

Case Temperature

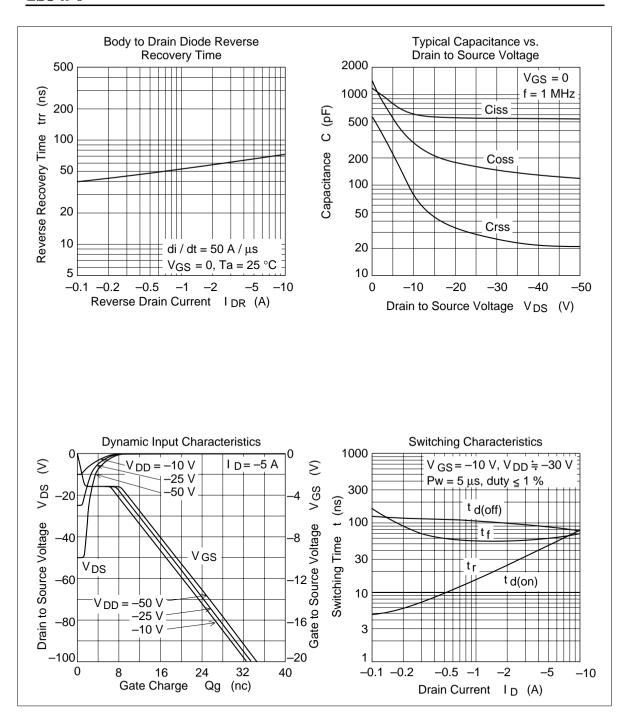
80

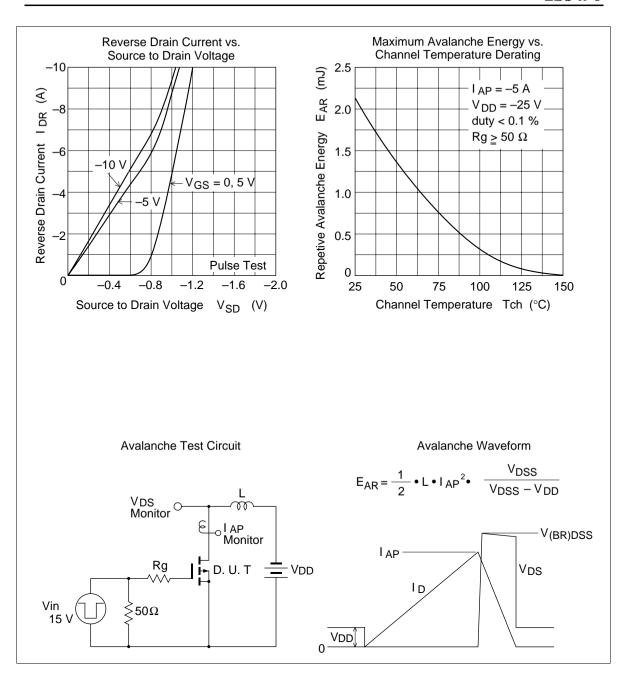
 $V_{DS} = -10 \text{ V}$ Pulse Test

-5

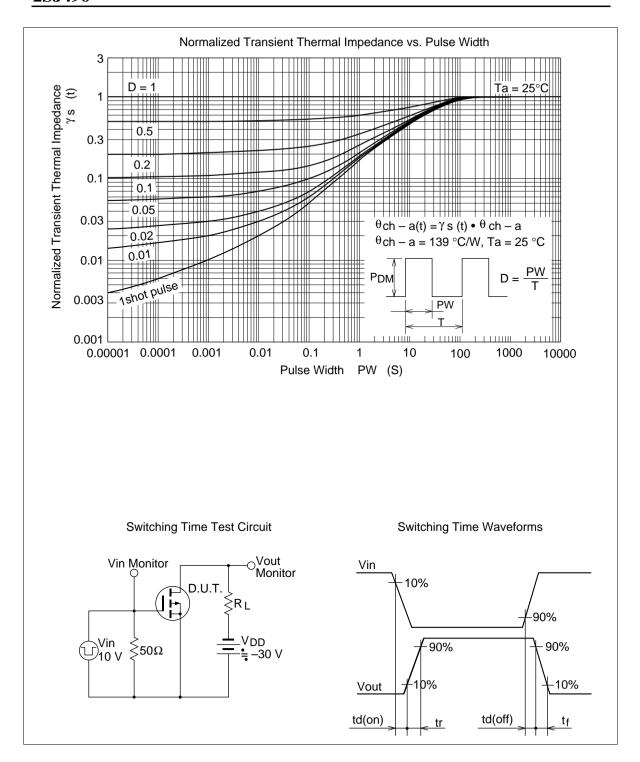
-10

-2



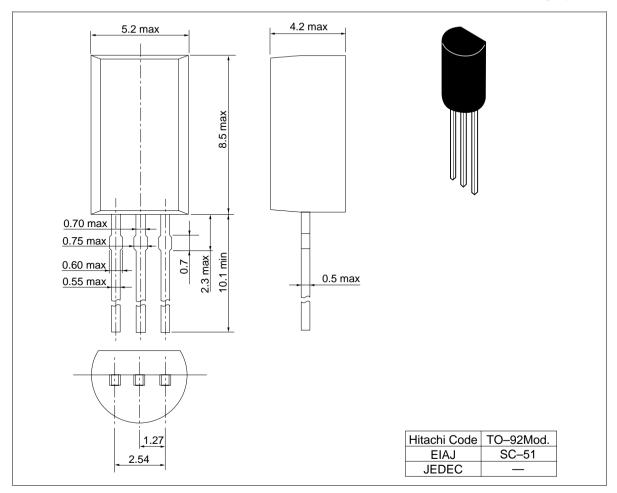


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Package Dimensions

Unit: mm



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